AUIRFI4905

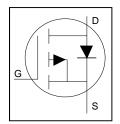
HEXFET® Power MOSFET

Features

- Advanced Planar Technology
- P-Channel MOSFET
- Low On-Resistance
- Dynamic dV/dT Rating
- 175°C Operating Temperature
- Fast Switching
- Fully Avalanche Rated
- Repetitive Avalanche Allowed up to Timax
- Lead-Free, RoHS Compliant
- Automotive Qualified *



Specifically designed for Automotive applications, this cellular design of HEXFET® Power MOSFETs utilizes the latest processing techniques to achieve low on-resistance per silicon area. This benefit combined with the fast switching speed an ruggedized device design that HEXFET Power MOSFETs are well known for, provides the designer with an extremely efficient and reliable device for use in Automotive and a wide variety of other applications.



V _{DSS}	-55V
R _{DS(on)} max.	20 mΩ
D (Silicon Limited)	-39A



G	D	S
Gate	Drain	Source

Base Part Number	Package Type	Standard	Orderable Part Number	
		Form	Quantity	
AUIRFI4905	TO-220 Full-Pak	Tube	50	AUIRFI4905

Absolute Maximum Ratings

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only; and functional operation of the device at these or any other condition beyond those indicated in the specifications is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability. The thermal resistance and power dissipation ratings are measured under board mounted and still air conditions. Ambient temperature (TA) is 25°C, unless otherwise specified.

	Parameter	Max.	Units
$I_D @ T_{C \text{ (Bottom)}} = 25^{\circ}C$	Continuous Drain Current, V _{GS} @ -10V (Silicon Limited)	-39	
I _D @ T _{C (Bottom)} = 100°C	Continuous Drain Current, V _{GS} @ -10V (Silicon Limited)	-27	Α
I _{DM}	Pulsed Drain Current ①	-155	
P _D @T _{C (Bottom)} = 25°C	Power Dissipation	55	W
	Linear Derating Factor	0.37	W/°C
V_{GS}	Gate-to-Source Voltage	± 20	V
E _{AS}	Single Pulse Avalanche Energy (Thermally Limited) ②	1247	mJ
I _{AR}	Avalanche Current ①	See Fig. 14, 15, 22a, 22b	Α
E _{AR}	Repetitive Avalanche Energy ①		
T」	Operating Junction and	-55 to + 175	°C
T _{STG}	Storage Temperature Range		°C

Thermal Resistance

Symbol	Parameter	Тур.	Max.	Units
$R_{\theta JC}$	Junction-to-Case ®		2.73	°C/W
$R_{\theta JA}$	Junction-to-Ambient		65	

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^{*}Qualification standards can be found at http://www.irf.com/



Static Electrical Characteristics @ T_J = 25°C (unless otherwise specified)

	- • •	•	,			
Symbol	Parameter	Min.	Тур.	Max.	Units	Conditions
$V_{(BR)DSS}$	Drain-to-Source Breakdown Voltage	-55			V	$V_{GS} = 0V, I_D = -250\mu A$
$\Delta V_{(BR)DSS}/\Delta T_J$	Breakdown Voltage Temp. Coefficient		-0.049		V/°C	Reference to 25°C, $I_D = -1.0$ mA
R _{DS(on)}	Static Drain-to-Source On-Resistance			20	mΩ	$V_{GS} = -10V, I_D = -23A \oplus$
$V_{GS(th)}$	Gate Threshold Voltage	-2.0		-4.0	V	$V_{DS} = V_{GS}$, $I_D = -250\mu A$
gfs	Forward Transconductance	17			S	$V_{DS} = -10V, I_{D} = -23A$
	Duein to Course Leelings Courset			-25		$V_{DS} = -55V, V_{GS} = 0V$
I _{DSS}	Drain-to-Source Leakage Current			-250	μA	$V_{DS} = -44V, V_{GS} = 0V, T_{J} = 125^{\circ}C$
I _{GSS}	Gate-to-Source Forward Leakage			100	A	$V_{GS} = 20V$
	Gate-to-Source Reverse Leakage			-100	nA	$V_{GS} = -20V$

Dynamic Electrical Characteristics @ T_J = 25°C (unless otherwise specified)

Symbol	Parameter	Min.	Тур.	Max.	Units	Conditions
Q_g	Total Gate Charge		110	165		$I_D = -23A$
Q_{gs}	Gate-to-Source Charge		18		nC	$V_{DS} = -44V$
Q_{gd}	Gate-to-Drain ("Miller") Charge		51			V _{GS} = -10V ④
$t_{d(on)}$	Turn-On Delay Time		14			$V_{DD} = -55V$
t _r	Rise Time		45		ns	$I_D = -23A$
$t_{d(off)}$	Turn-Off Delay Time		71			$R_G = 2.7\Omega$
t _f	Fall Time		61			V _{GS} = -10V ④
L_D	Internal Drain Inductance		4.5			Between lead,
					nΗ	6mm (0.25in.)
Ls	Internal Source Inductance		7.5			from package
						and center of die contact
C _{iss}	Input Capacitance		3560			$V_{GS} = 0V$
Coss	Output Capacitance		1290		pF	$V_{DS} = -25V$
C _{rss}	Reverse Transfer Capacitance		480			f = 1.0 MHz

Diode Characteristics

Symbol	Parameter	Min.	Тур.	Max.	Units	Conditions
	Continuous Source Current			-39	۸	MOSFET symbol
IS	(Body Diode)				А	showing the
	Pulsed Source Current			-155	۸	integral reverse
ISM	(Body Diode) ①				А	p-n junction diode.
V_{SD}	Diode Forward Voltage			-1.6	V	$T_J = 25^{\circ}C$, $I_S = -23A$, $V_{GS} = 0V$ ④
dv/dt	Peak Diode Recovery ③		2.8		V/ns	$T_J = 175$ °C, $I_S = -23$ A, $V_{DS} = -55$ V
t _{rr}	Reverse Recovery Time		64		ns	$T_J = 25$ °C, $I_F = -23$ A, $V_R = -28$ V
Q_{rr}	Reverse Recovery Charge		164		nC	di/dt = 100A/µs④

Notes:

- ① Repetitive rating; pulse width limited by max. junction temperature.
- @ Limited by $T_{Jmax},$ starting T_{J} = 25°C, L = 4.7mH, R_{G} = 50 $\!\Omega,\,I_{AS}$ = -23A, V_{GS} =-10V.
- $\label{eq:loss_spectrum} \mbox{ } \m$
- 4 Pulse width $\leq 400 \mu s$; duty cycle $\leq 2\%$.

<u>m</u> © 2013 International Rectifier September 11, 2013



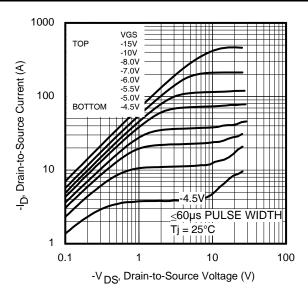


Fig. 1 Typical Output Characteristics

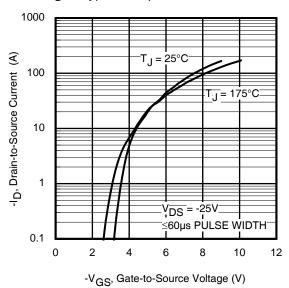


Fig. 3 Typical Transfer Characteristics

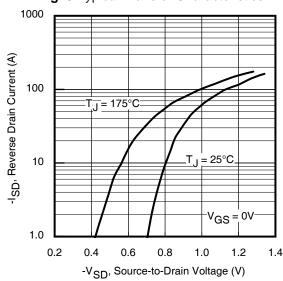


Fig. 5 Typical Source-to-Drain Diode Forward Voltage

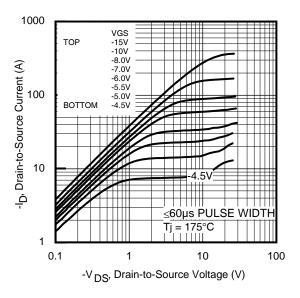


Fig. 2 Typical Output Characteristics

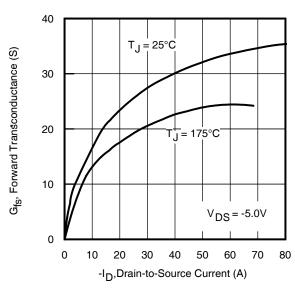


Fig. 4 Typical Forward Transconductance vs Drain Current

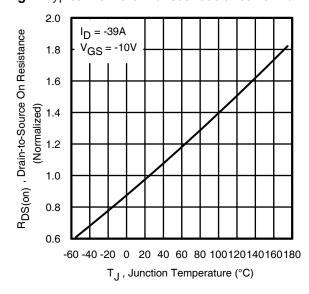


Fig. 6 Normalized On-Resistance vs. Temperature



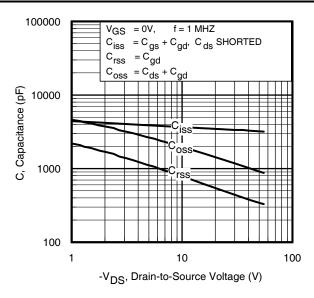


Fig 7. Typical Capacitance vs. Drain-to-Source Voltage

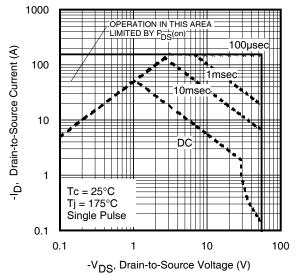


Fig 9. Maximum Safe Operating Area

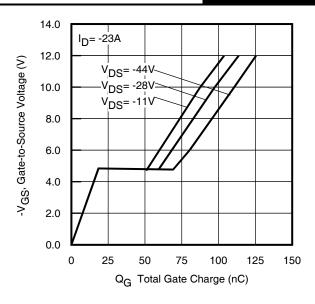


Fig 8. Typical Gate Charge vs. Gate-to-Source Voltage

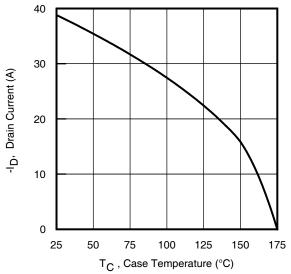


Fig 10. Maximum Drain Current vs. Case Temperature

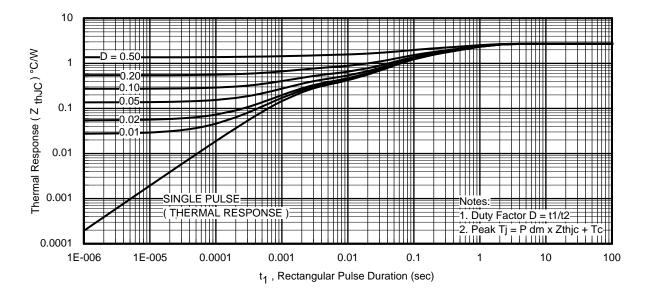


Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Case



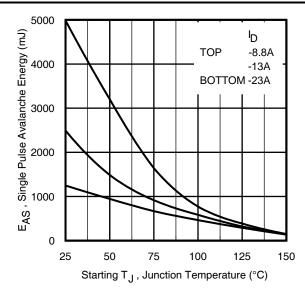


Fig 12. Maximum Avalanche Energy vs. Drain Current

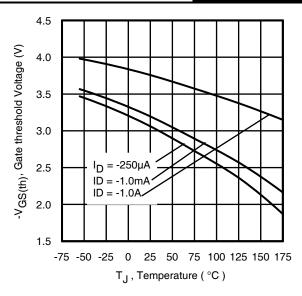


Fig 13. Threshold Voltage vs. Temperature

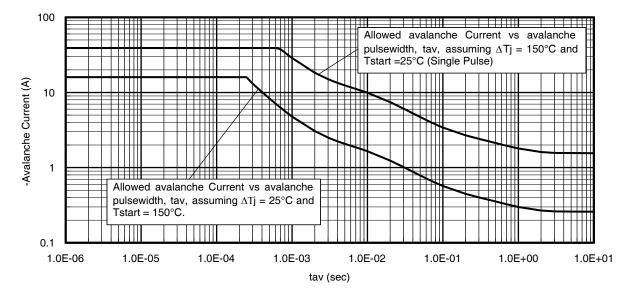


Fig 14. Typical Avalanche Current vs. Pulse Width

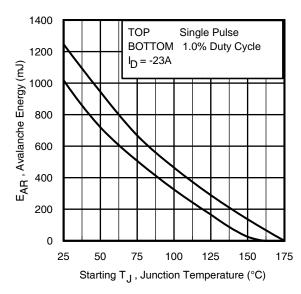


Fig 15. Maximum Avalanche Energy vs. Temperature

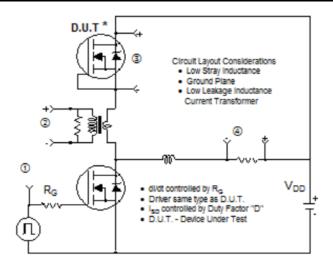
Notes on Repetitive Avalanche Curves , Figures 14, 15: (For further info, see AN-1005 at www.irf.com)

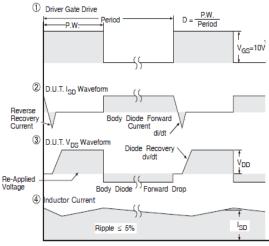
- (For further info, see AN-1005 at www.irf.com)

 1. Avalanche failures assumption:
 - Purely a thermal phenomenon and failure occurs at a temperature far in excess of T_{jmax}. This is validated for every part type.
- 2. Safe operation in Avalanche is allowed as long as T_{jmax} is not exceeded.
- 3. Equation below based on circuit and waveforms shown in Figures 16a, 16b.
- 4. PD (ave) = Average power dissipation per single avalanche pulse.
- BV = Rated breakdown voltage (1.3 factor accounts for voltage increase during avalanche).
- 6. lav = Allowable avalanche current.
- 7. ΔT = Allowable rise in junction temperature, not to exceed T_{jmax} (assumed as 25°C in Figure 14, 15).
 - tav = Average time in avalanche.
 - D = Duty cycle in avalanche = tav ·f
 - ZthJC(D, tav) = Transient thermal resistance, see Figures 13)

$$\begin{split} P_{D \text{ (ave)}} &= 1/2 \text{ (} 1.3 \cdot \text{BV} \cdot \text{I}_{av} \text{)} = \Delta \text{T} \text{/ } Z_{thJC} \\ I_{av} &= 2\Delta \text{T} \text{/ } [1.3 \cdot \text{BV} \cdot Z_{th}] \\ E_{AS \text{ (AR)}} &= P_{D \text{ (ave)}} \cdot t_{av} \end{split}$$







^{*} V_{GS} = 5V for Logic Level Devices

* Reverse Polarity of D.U.T for P-Channel

Fig 16. Peak Diode Recovery dv/dt Test Circuit for P-Channel HEXFET® Power MOSFETs

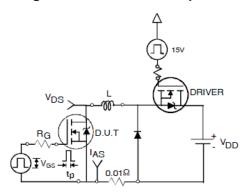


Fig 17a. Unclamped Inductive Test Circuit

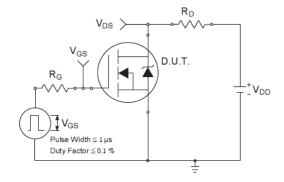


Fig 18a. Switching Time Test Circuit

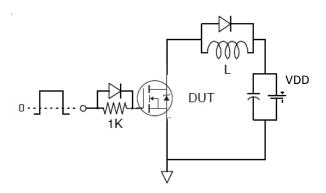


Fig 19a. Gate Charge Test Circuit

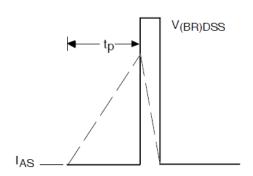


Fig 17b. Unclamped Inductive Waveforms

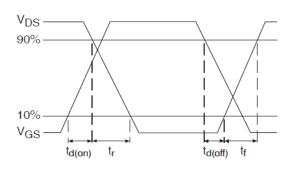


Fig 18b. Switching Time Waveforms

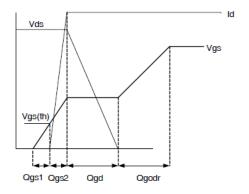
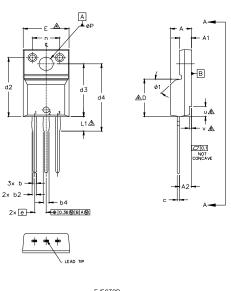


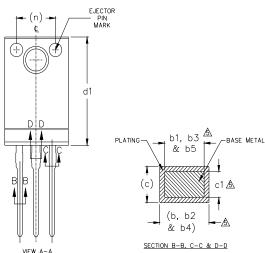
Fig 19b. Gate Charge Waveform



TO-220 Full-Pak Package Outline

Dimensions are shown in millimeters (inches)





NOTES:

- 1.0 DIMENSIONING AND TOLERANCING AS PER ASME Y14.5 M- 1994.
- DIMENSIONS ARE SHOWN IN MILLIMETERS [INCHES].

LEAD DIMENSION AND FINISH UNCONTROLLED IN L1.

DIMENSION D & E DO NOT INCLUDE MOLD FLASH. MOLD FLASH SHALL NOT EXCEED .005" (0.127) PER SIDE. THESE DIMENSIONS ARE MEASURED AT THE OUTER MOST EXTREMES OF THE PLASTIC BODY.

DIMENSION 61, 63, 65 & c1 APPLY TO BASE METAL ONLY.

STEP OPTIONAL ON PLASTIC BODY DEFINED BY DIMENSIONS u & v.

7.0 CONTROLLING DIMENSION: INCHES.

S					
S Y M		DIMEN	SIONS		N
B	MILLIM	ETERS	IN	CHES	O T E S
L	MIN.	MAX.	MIN.	MAX.	S
Α	4.57	4.83	.180	.190	
A1	2.57	2.83	.101	.111	
A2	2.41	2.92	.095	.115	
ь	0.62	.094	0.24	.037	
ь1	0.62	0.89	.024	0.35	5
b2	0.76	1.27	.030	.050	
ь3	0.76	1.22	.030	.048	5
b4	1.02	1.52	.040	.060	
b5	1.02	1.47	.040	.058	5
С	0.33	0.63	.013	.025	
c1	0.33	0.58	.013	.023	5
D	8.65	9.80	.341	.386	4
d1	15.80	16.12	.622	.635	
d2	13.97	14.22	.550	.560	
d3	12.30	12.92	.484	.509	
d4	8.64	9.91	.340	.390	
E	9.63	10.63	.379	.419	4
е	2.54	BSC	.100	BSC	1
L	13.20	13.72	.520	.540	
L1	3.10	2.31	.122	.138	3
n	6.05	6.15	.238	.242	
ØΡ	3.05	3.45	.120	.136	
u	2.40	2.50	.094	.098	6
v	0.40	0.50	.016	.020	6
ø1	-	45°	-	45°	
	1				1

LEAD ASSIGNMENTS

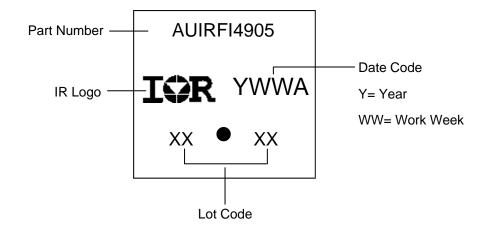
HEXFET

- 1.- GATE
- 2.- DRAIN
- 3.- SOURCE

IGBTs, CoPACK

- 1.- GATE 2.- COLLECTOR
- 3.- EMITTER

TO-220 Full-Pak Part Marking Information

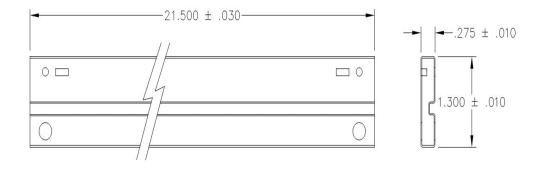


TO-220AB Full-Pak packages are not recommended for Surface Mount Application.

Note: For the most current drawing please refer to IR website at http://www.irf.com/package/



TO-220AB Full-Pak Tube Sketch



Qualification Information[†]

Qualification information		Automotive			
		(per AEC-Q101)			
Qualificat	ion Level	Comments: This part number(s) passed Automotive qualification. Industrial and Consumer qualification level is granted by extension higher Automotive level.			
Moisture S	isture Sensitivity Level TO-220 Full-Pak N/A				
	Machine Model	Class M4 (+/- 700V) ^{††}			
		AEC-Q101-002			
	Human Body Model	Class H2 (+/- 4000V) ^{††}			
ESD		AEC-Q101-001			
	Charged Device Model	Class C5 (+/- 2000V) ^{††}			
			AEC-Q101-005		
RoHS Compliant		Yes			

- † Qualification standards can be found at International Rectifier's web site: http://www.irf.com/
- †† Highest passing voltage.

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http://www.irf.com/technical-info/

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